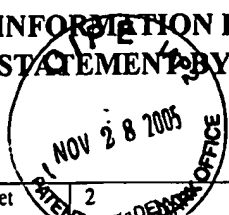


FORM PTO-1449/A and B (Modified)		APPLICATION NO.: 09/352,494	ATTY. DOCKET NO.: Z2002-700110 (Prior Docket No. 03588.P002)
INFORMATION DISCLOSURE STATEMENT BY APPLICANT		FILING DATE: July 13, 1999	CONFIRMATION NO.: 2351
		APPLICANT: Kevin Brehmer et al.	
		GROUP ART UNIT: 2612	EXAMINER: Tuan V. Ho
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OTHER ART - NON PATENT LITERATURE DOCUMENTS

Examiner's Initials	Cite No	Include name of the author (in CAPITAL LETTERS) title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, relevant page(s), volume-issue number(s), publisher, city and/or country where published.	Translation (Y/N)
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EXAMINER 	DATE CONSIDERED 2/3/06
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#EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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